ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INCLUSTRIES®	burn. Illinois, All rights reserved	under both The	is document vel parts, the	nt is a declaration e declaration en	n of the subst compasses al	tances wi ll lower le	ithin the manufacture evel materials for wh	er listed ite hich the ma	m. Note: if t nufacturer h	he item is an as as engineering	sembly with lower responsibility.
IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC-1752 Standard	Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg Information			
Supplier Information											
Company name*	ny name* Company unique ID			Unique ID Authority				Response Date*			
onsemi								2023-06-08			
Contact Name	Title - Contact		P	Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance		Ν	NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	d Representative* Title - Representative			Phone - Representative*				Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance	ance		NA			Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Item	n Number Mfr Item Name	Mfr Item Name		Effective Date	Version	Manufacturing Site		W	eight*	UOM	Unit Type
NCV85' G	70BMN250R2 200MA ULN RI	F LDO REG2.5V	2	2023-06-08 MY		Y1	20	.0	mg	Each	
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Ra	ating	Peak Process Body Temperat		perature	ure Max Time at Peak Tempera		e Number	of Reflow Cyc	les
Matte Tin (Sn) - annealed	CU Alloy			260			<b>30</b> se		seconds 3		
Comments											
level 1 - maximum time at peak temperature during so	oldering is 10-30 seconds										
For more information regarding material composition	please refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.2	mg	Supplier	Silicon (Si)	7440-21-3		0.2	mg
Die Attach (	0.45	mg	Supplier	Silver (Ag)	7440-22-4		0.3375	mg
			Supplier	Epoxy resins	129915-35-1		0.1125	mg
Lead Frame 6.97	6.97	mg	Supplier	Silver (Ag)	7440-22-4		1.9446	mg
			Supplier	Iron (Fe)	7439-89-6		0.0767	mg
			Supplier	Copper (Cu)	7440-50-8		4.9487	mg
Mold Compound-Black 10.0	10.0	mg		Epoxy resin	proprietary data		0.7	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.5	mg
			Supplier	Carbon Black (C)	1333-86-4		0.05	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7.05	mg
Plating	0.71	mg	Supplier	Tin (Sn)	7440-31-5		0.71	mg
Wire Bond - Au	1.67	mg	Supplier	Gold (Au)	7440-57-5		1.67	mg